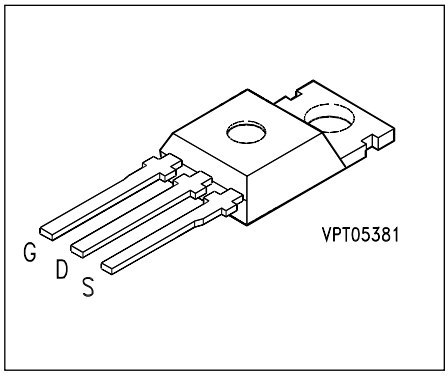
SIEMENS

SIPMOS® Power Transistors

BUZ 73
BUZ 73 A

- N channel
- Enhancement mode
- Avalanche-rated



Type	V_{DS}	I_D	T_C	$R_{DS\ (on)}$	Package [1]	Ordering Code
BUZ 73	200 V	7.0 A	28 ˚C	0.4 Ω	TO-220 AB	C67078-S1317-A2
BUZ 73 A	200 V	5.5 A	37 ˚C	0.6 Ω	TO-220 AB	C67078-S1317-A3

Maximum Ratings

Parameter	Symbol	BUZ		Unit
		73	73 A	
Continuous drain current	I_D	**7.0**	**5.5**	A
Pulsed drain current, T_C = 25 ˚C	$I_{D\ puls}$	**28**	**22**	
Avalanche current, limited by $T_{j\ max}$	I_{AR}	**7.0**		
Avalanche energy, periodic limited by $T_{j\ (max)}$	E_{AR}	**6.5**		mJ
Avalanche energy, single pulse I_D = 7 A, V_{DD} = 50 V, R_{GS} = 25 Ω L = 3.67 mH, T_j = 25 ˚C	E_{AS}	**120**		
Gate-source voltage	V_{GS}	± **20**		V
Power dissipation, T_C = 25 ˚C	P_{tot}	**40**		W
Operating and storage temperature range	T_j , T_{stg}	**– 55 ... + 150**		˚C

Thermal resistance, chip-case	$R_{th\ JC}$	≤ **3.1**	K/W
DIN humidity category, DIN 40 040	–	**E**	–
IEC climatic category, DIN IEC 68-1	–	**55/150/56**	

1) See chapter Package Outlines.

Electrical Characteristics

at T_j = 25 ˚C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static characteristics					
Drain-source breakdown voltage V_{GS} = 0 V, I_D = 0.25 mA	$V_{(BR)\ DSS}$	200	–	–	V
Gate threshold voltage V_{GS} = V_{DS} , I_D = 1 mA	$V_{GS\ (th)}$	2.1	3.0	4.0	
Zero gate voltage drain current V_{DS} = 200 V, V_{GS} = 0 V T_j = 25 ˚C T_j = 125 ˚C	I_{DSS}	 – –	 0.1 10	 1.0 100	µA
Gate-source leakage current V_{GS} = 20 V, V_{DS} = 0 V	I_{GSS}	–	10	100	nA
Drain-source on-resistance V_{GS} = 10 V, I_D = 4.5 A BUZ 73 BUZ 73 A	$R_{DS\ (on)}$	 – –	 0.3 0.5	 0.4 0.6	Ω
Dynamic characteristics					
Forward transconductance V_{DS} ≥ 2 x I_D x $R_{DS(on)max}$, I_D = 4.5 A	g_{fs}	3.0	4.2	–	S
Input capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{iss}	–	400	530	pF
Output capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{oss}	–	85	130	
Reverse transfer capacitance V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz	C_{rss}	–	45	70	
Turn-on time t_{on} , (t_{on} = $t_{d\ (on)}$ + t_r) V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3.0 A, R_{GS} = 50 Ω	$t_{d\ (on)}$	–	10	15	ns
	t_r	–	40	60	
Turn-off time t_{off} , (t_{off} = $t_{d\ (off)}$ + t_f) V_{DD} = 30 V, V_{GS} = 10 V, I_D = 3.0 A, R_{GS} = 50 Ω	$t_{d\ (off)}$	–	55	75	
	t_f	–	30	40	

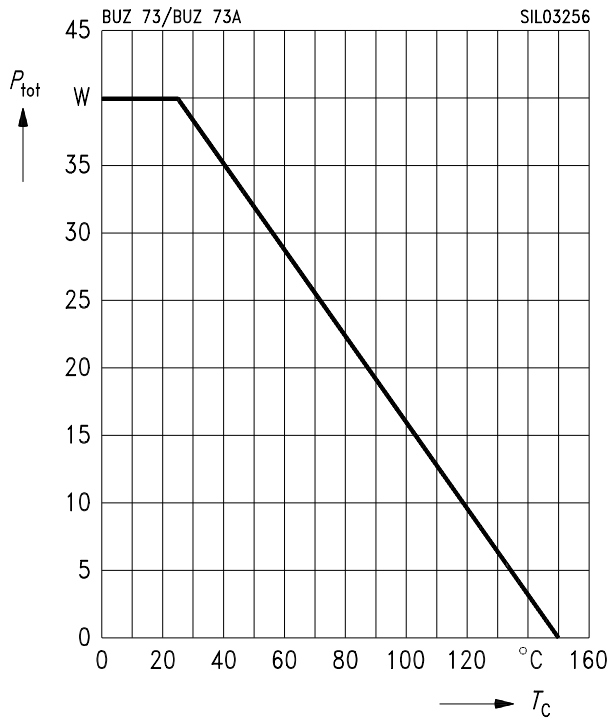
Electrical Characteristics (cont'd)
at T_j = 25 ˚C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse diode					
Continuous reverse drain current T_C = 25 ˚C BUZ 73 BUZ 73 A	I_S	 – –	 – –	 7.0 5.5	A
Pulsed reverse drain current T_C = 25 ˚C BUZ 73 BUZ 73 A	I_{SM}	 – –	 – –	 28 22	
Diode forward on-voltage I_S = 14 A, V_{GS} = 0 V	V_{SD}	–	1.3	1.7	V
Reverse recovery time V_R = 100 V, $I_F = I_S$, di_F / dt = 100 A/µs	t_{rr}	–	200	–	ns
Reverse recovery charge V_R = 100 V, $I_F = I_S$, di_F / dt = 100 A/µs	Q_{rr}	–	0.60	–	µC

Characteristics at T_j = 25 °C, unless otherwise specified.

Total power dissipation

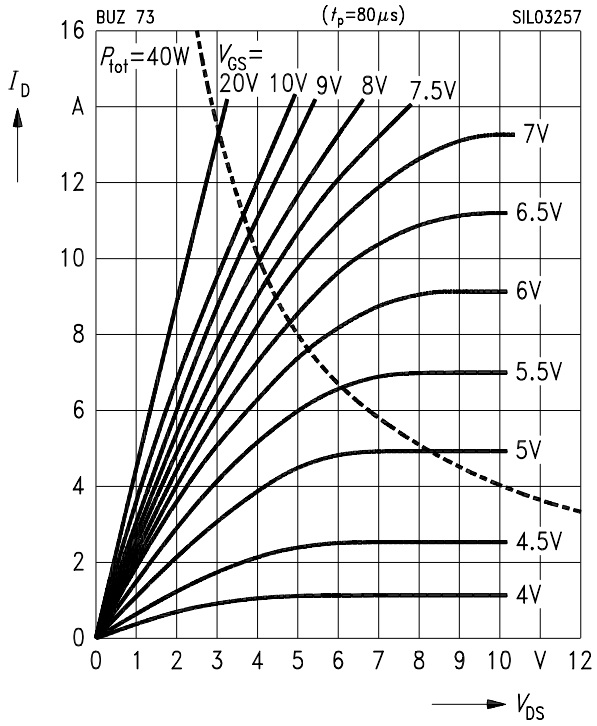
$P_{tot} = f(T_C)$



Typ. output characteristics

$I_D = f(V_{DS})$ **BUZ 73**

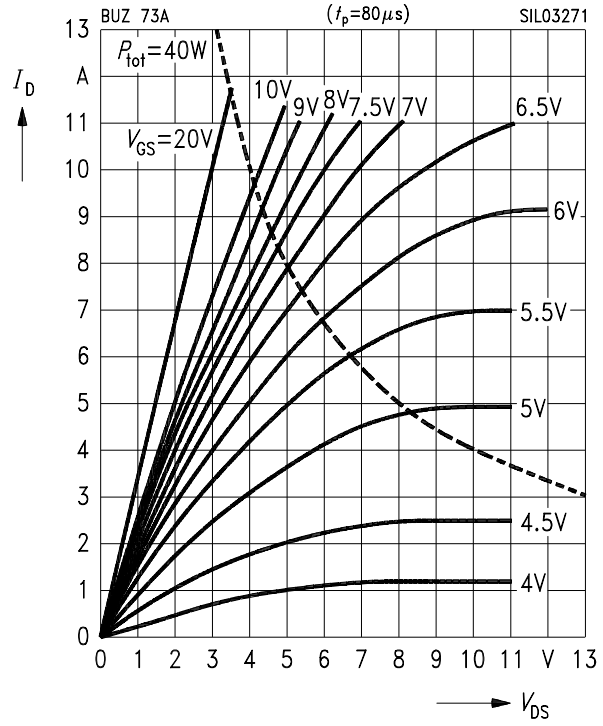
parameter: t_p = 80 µs



Typ. output characteristics

$I_D = f(V_{DS})$ **BUZ 73 A**

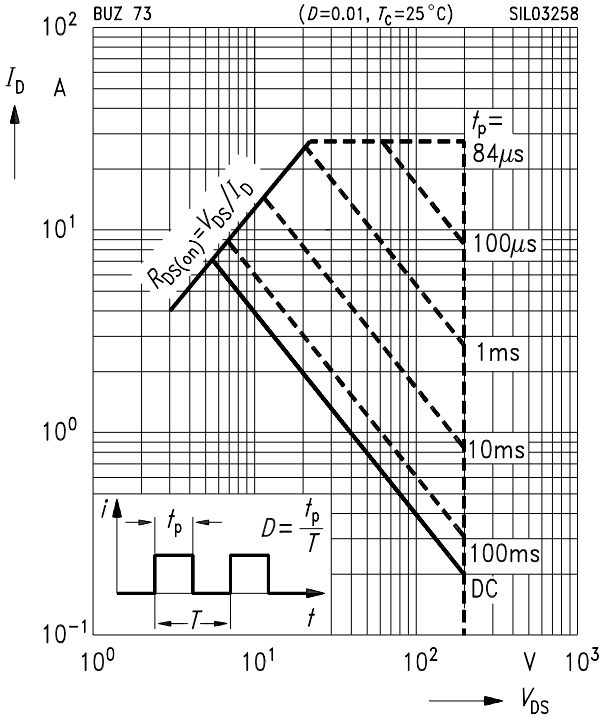
parameter: t_p = 80 µs



Safe operating area

$I_D = f(V_{DS})$ **BUZ 73**

parameter: D = 0.01, T_C = 25 °C



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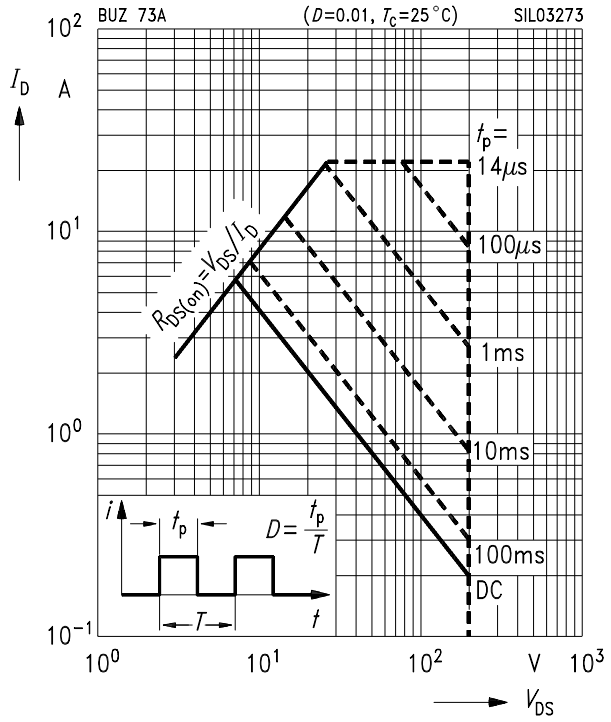
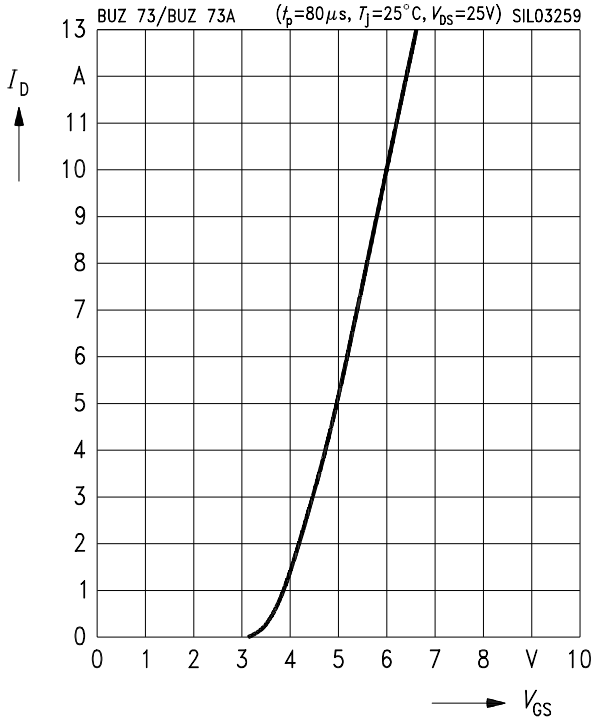


Typ. transfer characteristics

$I_D = f(V_{GS})$

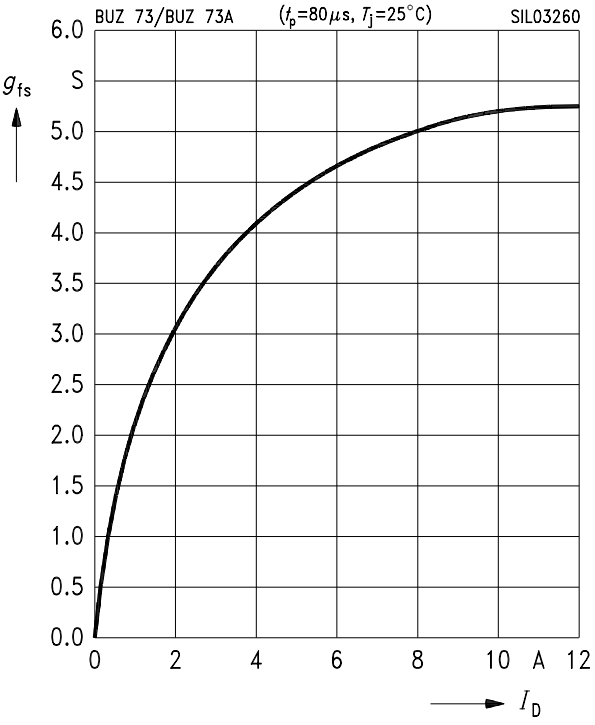
parameter: t_p = 80 µs, V_{DS} = 25 V



Typ.forward transconductance

$g_{fs} = f(I_D)$

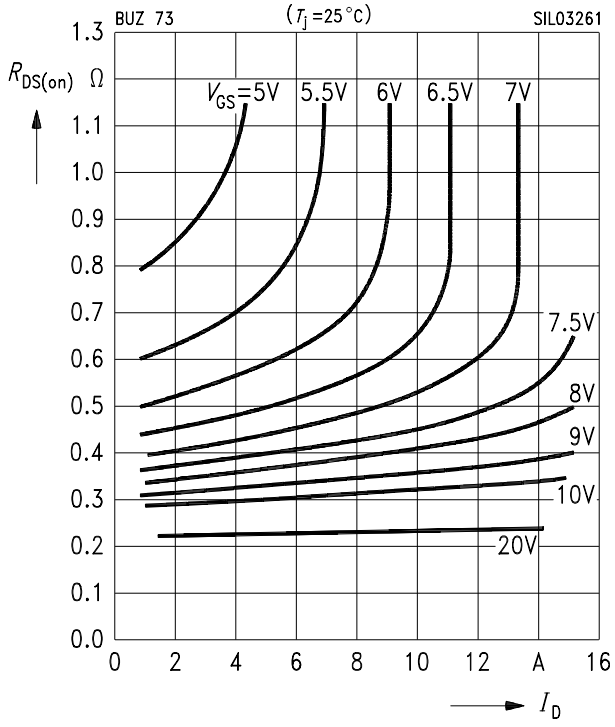
parameter: t_p = 80 µs



Typ. drain-source on-resistance

$R_{DS\,(on)} = f(I_D)$ **BUZ 73**

parameter: V_{GS}



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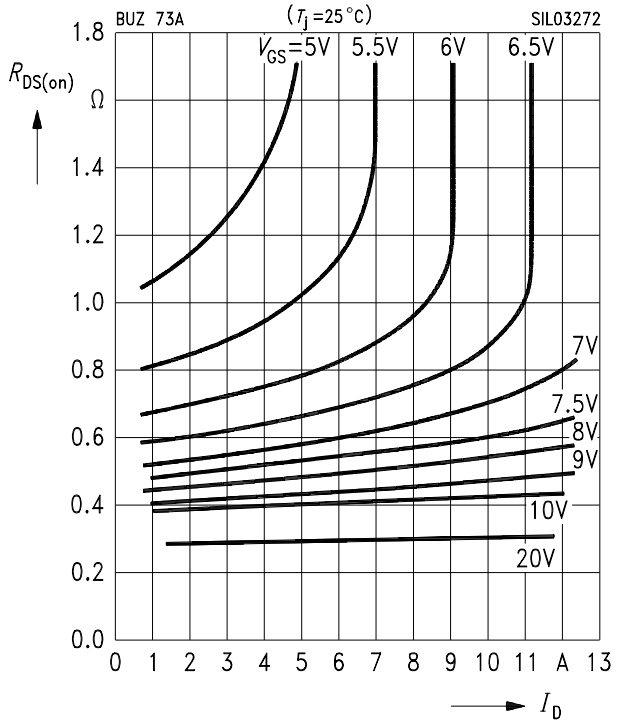
$R_{DS\,(on)} = f\,(I_D)$ **BUZ 73 A**

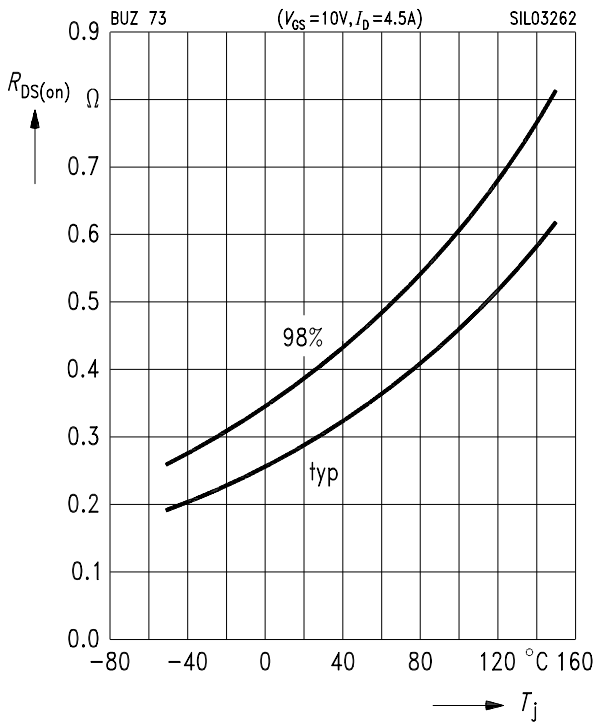
parameter: V_{GS}



Drain-source on-resistance

$R_{DS\,(on)} = f\,(T_j)$ **BUZ 73**

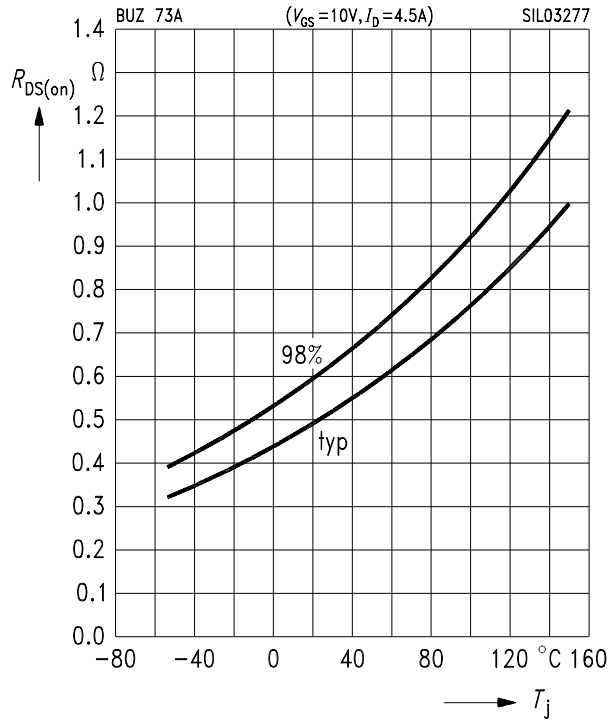
parameter: I_D = 4.5 A, V_{GS} = 10 V, (spread)



Drain-source on-resistance

$R_{DS\,(on)} = f\,(T_j)$ **BUZ 73 A**

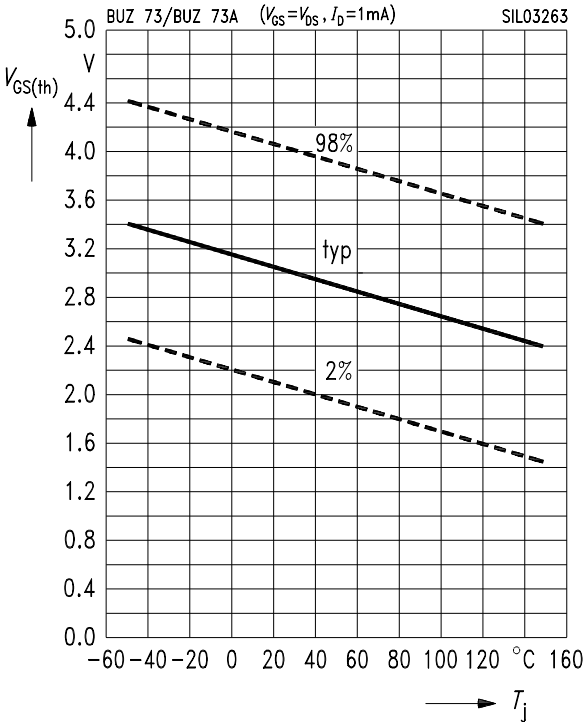
parameter: I_D = 4.5 A, V_{GS} = 10 V, (spread)



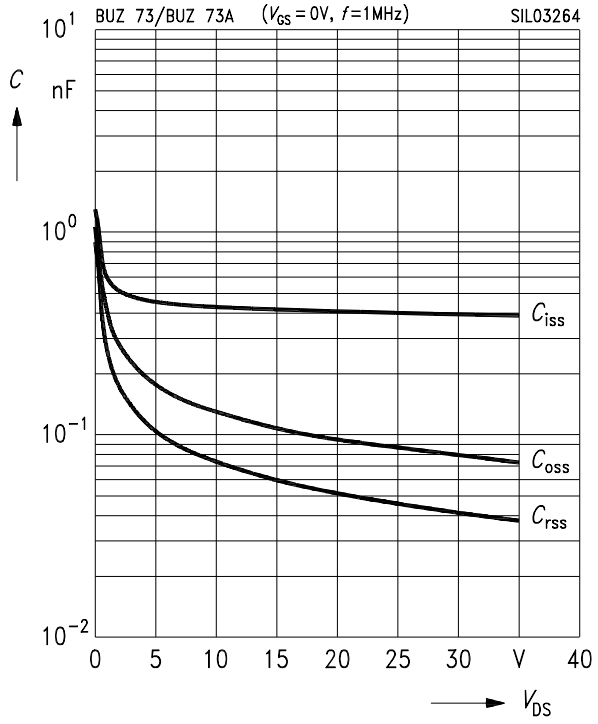
Gate threshold voltage

$V_{GS\,(th)} = f\,(T_j)$

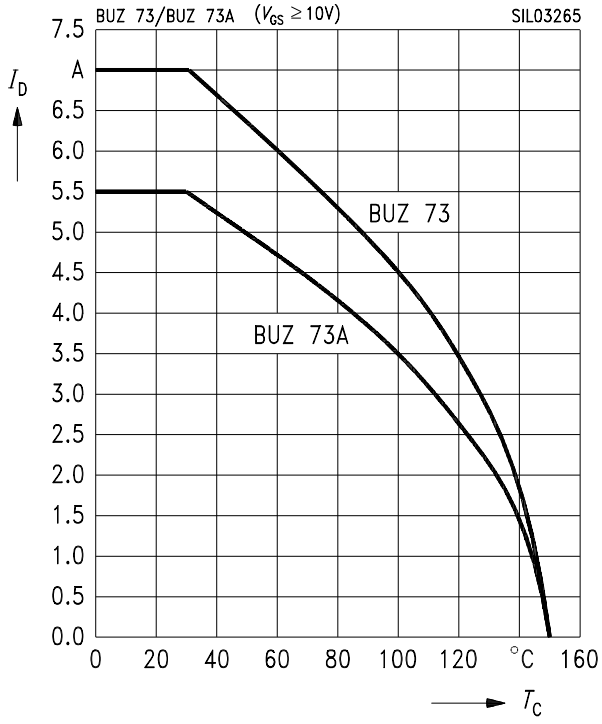
parameter: $V_{GS} = V_{DS}$, I_D = 1 mA, (spread)



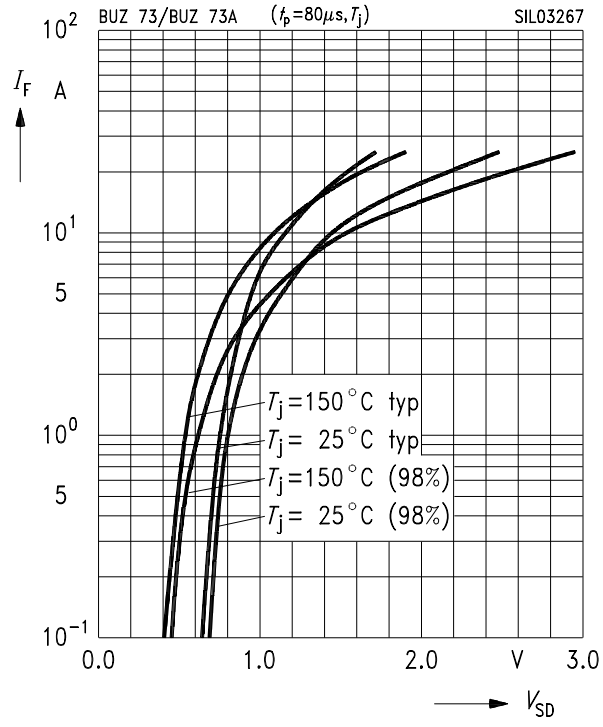
Typ. capacitances
$C = f(V_{DS})$
parameter: V_{GS} = 0 V, f = 1 MHz



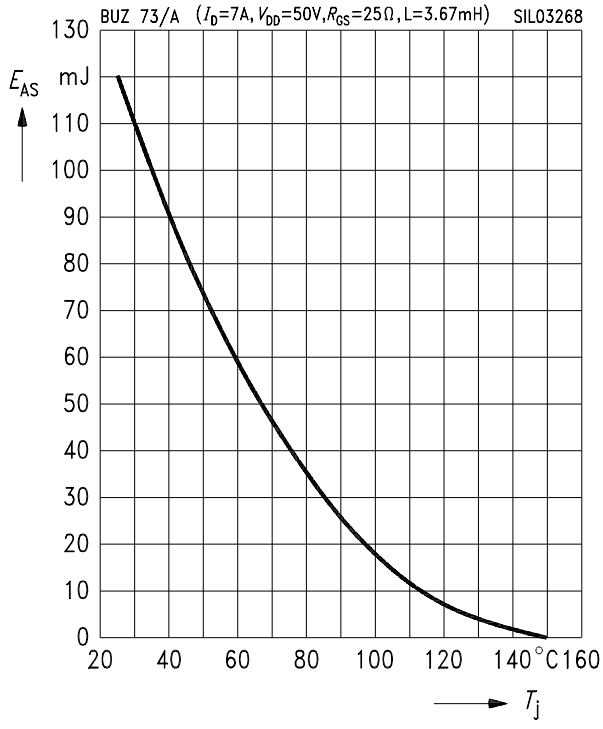
Drain current
$I_D = f(T_C)$
parameter: $V_{GS} \geq 10$ V



Forward characteristics of reverse diode
$I_F = f(V_{SD})$
parameter: T_j , t_p = 80 µs



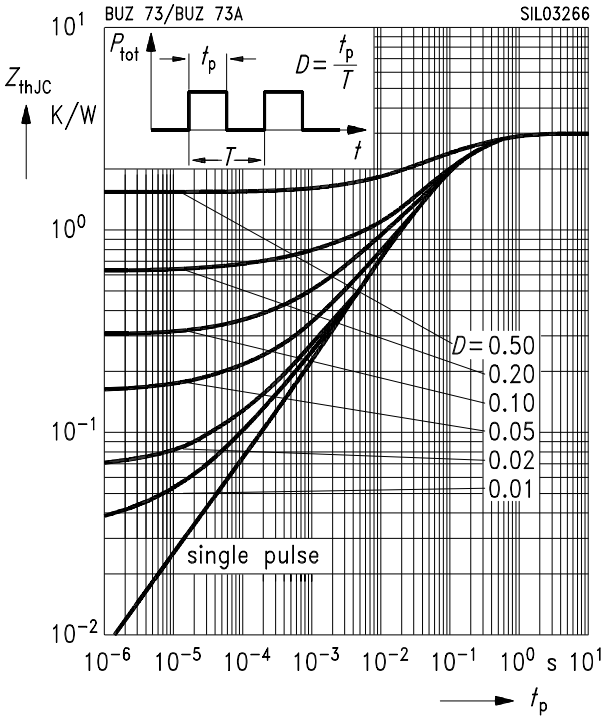
Avalanche energy $E_{AS} = f(T_j)$
parameter: I_D = 7 A, V_{DD} = 50 V
R_{GS} = 25 Ω, L = 3.67 mH



Transient thermal impedance

$Z_{th\,JC} = f(t_p)$

parameter: $D = t_p / T$



Typ. gate charge

$V_{GS} = f(Q_{Gate})$

parameter: $I_{D\,puls}$ = 13.5 A